

DETECTION APPARATUS AND DETECTING METHOD,  
DROPLET DISCHARGE APPARATUS AND DROPLET DISCHARGE METHOD,  
DEVICE AND ELECTRONIC EQUIPMENT

5 BACKGROUND OF THE INVENTION

Field of the Invention

The present invention relates to a detection apparatus and a detection method for a droplet discharge apparatus provided with a discharge head having a discharge nozzle capable of discharging droplets, and a droplet discharge apparatus.

10 Priority is claimed to Japanese Patent Applications No. 2002-312578, filed October 28, 2002, and No. 2003-297878, filed August 21, 2003, which are incorporated herein by reference.

Description of Related Art

15 Heretofore, photolithographic methods are used, primarily, for manufacturing devices with fine patterns. However, in recent years, attention has been given to a device manufacturing method using a droplet discharge system. In this technique, liquid material containing functional material is discharged from a discharge head in a droplet discharge apparatus, placing the material on a substrate in order to form a pattern,  
20 and it is very effective from the standpoint of handling diversified small-quantity production. For a droplet discharge system in a droplet discharge apparatus, generally known systems are a piezo jet system in which a droplet of liquid material is discharged by the distortion of a piezoelectric element, or a method in which liquid material is discharged by the rapid generation of steam due to the application of heat.

25 A discharge head has a plurality of discharge nozzles. However, sometimes

liquid material cannot be discharged from some of the discharge nozzles because of clogging, or the like, for example. If there is a discharge nozzle (non-performing nozzle) that cannot discharge droplet, then dots will be missing when a dot pattern is formed by discharging droplets onto a substrate. Japanese Patent Application

5 Laid-Open, No. 11-78051 discloses a technique regarding a method of detecting missing dots (non-performing nozzle detection method) in relation to a printer (printing device). In this technique, an ink droplet is discharged from an ink nozzle such that it passes through the detection region of a photo sensor, and it is determined whether the ink droplet is discharged from the ink nozzle based on a drop in the amount of light received  
10 by the photo sensor.

The above-described conventional art is effective because it can detect accurately whether an ink droplet is discharged from an ink nozzle or not, without improving sensor sensitivity, by adjusting the amount of ink discharged in droplets per unit time, or the discharge interval. However, in a case where only the discharge  
15 amount is increased or the discharge interval is shortened, there is a possibility that detection of ink droplets cannot be performed accurately by a photo sensor.

The present invention takes such conditions into consideration, with an object of providing a detection apparatus and a detecting method for a droplet discharge apparatus that can perform accurate detection when detecting whether a droplet is discharged from  
20 a discharge nozzle of the droplet discharge apparatus, and a droplet discharge apparatus.

## SUMMARY OF THE INVENTION

A first aspect of the present invention is a detection apparatus for detecting a droplet discharged from a discharge nozzle provided in a discharge head, has a light  
25 emitter for emitting a detection light, a receiver for receiving said detection light, and a

moving device for moving said discharge head in a direction to intersect the optical path of said detection light, said moving device moving said discharge head in said direction of movement, said discharge nozzle discharging said droplets at a predetermined time interval, and when  $D$  is the diameter of a beam of said detection light,  $d$  is the diameter of said droplets,  $L$  is the distance between the discharge nozzles in the direction of movement of said discharge head, and  $H$  is the relative distance that said discharge head and said detection apparatus move from when a discharge nozzle discharges one droplet to when said discharge nozzle discharges the next droplet, settings are adjusted so as to satisfy the conditions

$$D/2 + d/2 \leq L \dots (1), \text{ and}$$

$$H \leq D \dots (2).$$

A second aspect of the present invention is a detecting method for a droplet discharge apparatus having a discharge head with a plurality of discharge nozzles for discharging droplets, has the steps of emitting a detection light toward a predetermined receiver, discharging said droplets from said discharge nozzles at a predetermined time interval, detecting the amount of light received by said receiver due to said droplets passing through the optical path of said detection light, and when verifying the discharge state of the discharge nozzles based on the detected result, adjusting settings so as to satisfy the conditions

$$D/2 + d/2 \leq L, \text{ and } H \leq D,$$

where  $D$  is the diameter of the beam of said detection light,  $d$  is the diameter of said droplets,  $L$  is the distance between the discharge nozzles in the direction of movement of said discharge head, and  $H$  is the distance that said discharge head moves from when a discharge nozzle discharges one droplet to when said discharge nozzle discharges the next droplet.

Furthermore, a third aspect of the present invention is a droplet discharge apparatus has a discharge head with a plurality of discharge nozzles for discharging droplets arranged side by side in a predetermined direction, a detection apparatus for detecting whether said droplets are discharged from said discharge nozzles, and a control  
 5 unit for performing predetermined processing for said discharge head based on the detection result of said detection apparatus, wherein said detection apparatus has a light emitter for emitting a detection light, a receiver for receiving said detection light from said light emitter, and a moving device for moving said discharge head in a direction to intersect the optical path of said detection light, wherein said moving device moving said  
 10 discharge head in said direction of movement, said discharge nozzle discharging said droplets at a predetermined time interval, and when  $D$  is the diameter of a beam of said detection light,  $d$  is the diameter of said droplets,  $L$  is the distance between the discharge nozzles in the direction of movement of said discharge head, and  $H$  is the relative distance that said discharge head and said detection apparatus move from when a  
 15 discharge nozzle discharges one droplet to when said discharge nozzle discharges the next droplet, settings are adjusted so as to satisfy the conditions

$$D/2 + d/2 \leq L, \text{ and } H \leq D.$$

A fourth aspect of the present invention is a droplet discharge method has a step for discharging droplets from a discharge head with a plurality of discharge nozzles for  
 20 discharging droplets arranged side by side in a predetermined direction, a detection step for detecting whether said droplets are discharged from said discharge nozzles, and a processing step for performing predetermined processing for said discharge head based on a detection result of said detection step, wherein said detection step has the steps of radiating a detection light toward a predetermined receiver, discharging said droplets  
 25 from said discharge nozzles at a predetermined time interval, detecting the amount of

light received in said receiver due to said droplets passing through the optical path of said detection light, and when verifying the discharge state of the discharge nozzles based on the detected result, adjusting settings so as to satisfy the conditions

$$D/2 + d/2 \leq L, \text{ and } H \leq D,$$

5 where D is the diameter of the beam of said detection light, d is the diameter of said droplets, L is the distance between the discharge nozzles in the direction of movement of said discharge head, and H is the distance that said discharge head moves from when a discharge nozzle discharges one droplet to when said discharge nozzle discharges the next droplet.

10 Furthermore, a fifth aspect of the present invention is a device wherein at least one part thereof is formed by the above-described droplet discharge apparatus.

Moreover, a sixth aspect of the present invention is electronic equipment, wherein at least one part of a system component thereof is formed by the above-described droplet discharge apparatus.

15 According to the aspects described above, by optically detecting droplets discharged from discharge nozzles in a state where the above-described conditions are satisfied, it is possible to place only one droplet discharged from each discharge nozzle onto the optical path of a detection light, so that it is possible to detect accurately whether droplets are discharged from the discharge nozzles normally. That is, in FIG. 5 and FIG.

20 6, if the condition of the above equation (1) is not satisfied a state occurs in which for example two droplets discharged from each of two discharge nozzles are placed on the optical path of the detection light. Then even in a state where no droplet is discharged from the first discharge nozzle, and a droplet is discharged only from the second discharge nozzle, there is a case where the receiver makes an incorrect determination that  
25 a droplet is discharged from the first discharge nozzle, due to the existence of the droplet

from the second discharge nozzle on the optical path of the detection light. Furthermore, even if the discharge nozzles perform normal discharge operations, by the fact that the condition of the above equation (2) is not satisfied, the discharge head passes through the optical path of the detection light while one discharge nozzle discharges a first droplet  
5 and a second droplet. Therefore there is a defect in that even though droplets are discharged normally, they are not detected. However, by satisfying the above conditions, the occurrence of this defect can be avoided.

Furthermore, in a detection apparatus of a droplet discharge apparatus of the present invention, in a case where the diameter of the beam of the detection light is  
10 greater than the diameter of a measurement region of the receiver, it is desirable that  $D$  is the diameter of the measurement region. That is, in the case where the diameter of the beam of the detection light is the diameter of the measurement region of the receiver or greater, when a droplet passes through part of the optical path of the detection light, if the part through which it passes is outside of the measurement region, the receiver cannot  
15 detect that the droplet has passed. Therefore, in the case where the diameter of the beam of the detection light is greater than the diameter of the measurement region of the receiver that receives the detection light, the diameter  $D$  is set to the diameter of the measurement region.

Moreover, a detection apparatus of a droplet discharge apparatus of the present  
20 invention may be provided with a control device for resetting at least one of the values of  $D$ ,  $d$  and  $H$ .

Accordingly, in the case where the detection apparatus does not satisfy the above conditions, the control device can satisfy the above conditions by adjusting  $D$ ,  $d$  or  $H$ .

In a droplet discharge apparatus of the present invention, it is desirable that the  
25 number of the discharge nozzles can be optionally set. By so doing, it is possible to

form a device pattern in a range of sizes and shapes as desired. For example, it is possible to optionally set the number of discharge nozzles to be used by a control unit for controlling the discharge operation of the discharge nozzles.

Here, the abovementioned droplet discharge apparatus is used for manufacturing devices based on the droplet discharge method, including an ink jet device with an ink jet head. The ink jet head of the ink jet device is capable of discharging droplets material quantitatively by an ink jet method, and it can drop liquid material of 1 to 300 nanograms per dot, for example, continuously. The droplet discharge apparatus may also be a dispenser apparatus.

Liquid material (droplet) means a medium with a viscosity capable of being discharged (capable of dropping) from the discharge nozzle of a discharge head of a droplet discharge apparatus. It may be either water-soluble or oil soluble. Any material that has a fluidity (viscosity) capable of being discharged from a discharge nozzle or the like is acceptable, even if solid material is mixed in, provided it is essentially liquid. Furthermore, material contained in the liquid material may be heated to its melting point or higher and melted, or may be minute particles suspended in solvent. Moreover, the base material onto which droplets are discharged refers to not only a flat substrate, but may also be a substrate with a curved surface. Furthermore, it is not necessary for the pattern forming surface to be hard, and it may be any flexible surface such as a film, paper, rubber or the like, as well as glass, plastic, and metal.

Moreover, when manufacturing a device by discharging droplets of liquid material onto a base material from a discharge head of a droplet discharge apparatus, the liquid material contains functional material. Functional material means device forming material that exhibits a predetermined function when placed on a base material (substrate). Functional materials include liquid crystal element forming material for

forming liquid crystal devices (liquid crystal elements) including color filters, organic EL element forming material for forming organic EL (electroluminescent) devices (organic EL elements), wire pattern forming material including metal for forming wire patterns to distribute electric power, and the like.

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#### BRIEF DESCRIPTION OF THE DRAWINGS

FIG. 1 is a schematic perspective view showing an embodiment of a droplet discharge apparatus incorporating a detection apparatus of the present invention.

FIG. 2 shows a discharge head.

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FIG. 3 shows the discharge head.

FIG. 4 is a schematic perspective view showing an embodiment of the detection apparatus.

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FIG. 5 is a schematic diagram showing how droplets discharged from a discharge head pass through the optical path of a detection light of the detection apparatus.

FIG. 6 is a schematic diagram to describe the distance that the discharge head moves from when a discharge nozzle discharges one droplet to when it discharges the next droplet.

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FIG. 7 is a schematic diagram showing an example of a detection operation in a case where the diameter of the beam of a detection light is larger than the measuring region of a receiver.

FIG. 8A to FIG. 8F show a manufacturing process for a color filter as an example of a device.

FIG. 9 is a sectional side elevation of an organic EL device.

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FIG. 10 is an exploded perspective view of a plasma display.

FIG. 11 is a flow chart for explaining a pattern forming method.

FIG. 12A and FIG. 12B are schematic diagrams showing an example of a pattern forming method.

FIG. 13A and FIG. 13B are schematic diagrams showing an example of a pattern forming method.

FIG. 14A and FIG. 14B are schematic diagrams showing an example of a pattern forming method.

FIG. 15A to FIG. 15D are diagrams for describing a process of a micro lens manufacturing method.

FIG. 16A and FIG. 16B are schematic diagrams of an electron source substrate of an image display device.

FIG. 17A to FIG. 17C are diagrams for explaining the manufacturing process of the image display device.

FIG. 18A to FIG. 18C are diagrams showing examples of electronic equipment in which these devices are installed.

## DETAILED DESCRIPTION OF THE INVENTION

Hereunder is a description of a droplet discharge apparatus having a detection apparatus of the present invention, with reference to the figures.

FIG. 1 is a schematic perspective view showing an embodiment of a droplet discharge apparatus incorporating a detection apparatus of the present invention.

In FIG. 1, a droplet discharge apparatus 10 is provided with; a discharge head 1 for discharging droplets, being liquid material, a stage device 2 for supporting a substrate P, being a base material for manufacturing a device, a carrier device 3 for carrying the substrate P to and from (loading and unloading) the stage device 2, and a control unit

CONT for control of the overall operation of the droplet discharge apparatus IJ including the discharge operation of the discharge head 1. In the present embodiment, the carrier device 3 has a robot arm, and is arranged in the -X direction in the figure, of the stage device 2. The discharge head 1 has a plurality of discharge nozzles 11 (refer to FIG. 2) on its discharge surface 1P, which discharge droplets of liquid material. In the present embodiment, the plurality of discharge nozzles 11 is arranged in at least the X axis direction (predetermined direction) on the discharge surface 1P of the discharge head 1. The liquid material is stored in a storage unit (tank), which is not shown in the figure, and is discharged from the discharge head 1 via tubes. The droplet discharge apparatus IJ places liquid material onto the surface of the substrate P from the discharge head 1 to deposit functional material contained in the liquid material. The discharge head 1 is capable of being moved in the XY directions (horizontal directions) in the figure by a moving device 4, and is also capable of moving in the Z direction (vertical direction). Furthermore, the discharge head 1 is capable of moving in the  $\theta X$  direction (rotating around the X axis),  $\theta Y$  direction (rotating around the Y axis), and  $\theta Z$  direction (rotating around the Z axis). The stage device 2 is capable of being moved in the X and Y directions by a driving device 5, and is also capable of moving in the Z direction and the  $\theta Z$  direction. The stage device 2 supporting the substrate P is capable of being moved relative to the discharge head 1 by the moving device 4 and the driving device 5.

A cleaning unit 6 for cleaning the discharge head 1 and a capping unit 7 for capping the discharge head 1 are provided at a separate location from the stage device 2, that is, a separate location from the location where droplets are discharged by the discharge head 1 for manufacturing devices. In the present embodiment, the cleaning unit 6 and the capping unit 7 are provided in the +Y direction of the stage device 2. The cleaning unit 6 cleans the discharge nozzles 11 of the discharge head 1. When cleaning,

the discharge head 1 is first positioned relative to the cleaning unit 6, and the cleaning unit 6 and the discharge surface 1P of the discharge head 1 are connected. Next, the cleaning unit 6 draws air out from the space formed between the cleaning unit 6 and the discharge surface 1P of the discharge head 1. By the space being evacuated, liquid material present in the discharge nozzles 11 of the discharge head 1 is sucked out, thus the discharge head 1 and the discharge nozzles 11 are cleaned. Furthermore, the capping unit 7 prevents the discharge surface 1P of the discharge head 1 from drying out, and caps the discharge surface 1P during stand-by time in which no device is manufactured.

FIG. 2 is an exploded perspective view of the discharge head 1, and FIG. 3 is a partially sectioned perspective view of the discharge head 1. As shown in FIG. 2, the discharge head 1 has a nozzle plate 10 with discharge nozzles 11, a pressure chamber substrate 13 with a diaphragm 12, and a case 14, in which the nozzle plate 10 and the diaphragm 12 are fitted and supported. As shown in FIG. 3, the main part of the discharge head 1 has a structure whereby the pressure chamber substrate 13 is sandwiched between the nozzle plate 10 and the diaphragm 12. The pressure chamber substrate 13 is formed from a silicon monocrystal substrate or the like, and has a plurality of cavities (pressure chambers) 16 formed by etching. The discharge nozzles 11 are formed at locations in the nozzle plate 10 corresponding to the cavities 16 when the nozzle plate 10 and the pressure chamber substrate 13 are bonded together.

Side walls 17 separate the plurality of cavities 16. Each of the cavities 16 is linked to a reservoir 15, being a common flow path, via a supply port 18. The diaphragm 12 is formed for example from a thermally oxidized film or the like. The diaphragm 12 has a tank aperture 19, and liquid material is supplied from the tank aperture 19 via a tube connected to the tank. Piezoelectric elements 20 are provided at

locations corresponding to the cavities 16 in the diaphragm 12. Each of the piezoelectric elements 20 has a structure in which piezoelectric ceramic crystals such as PZT elements or the like are sandwiched between a top electrode and a bottom electrode (not shown in the figure). The piezoelectric elements 20 are deformed in accordance  
5 with an applied voltage.

Referring back to FIG. 1, the droplet discharge apparatus IJ is provided with a detection apparatus 30 that detects whether droplets of liquid material are discharged from the discharge nozzles 11 of the discharge head 1. The detection apparatus 30 is provided at a separate location from the stage device 2, that is, at a separate location from  
10 the location where the droplet discharge operation is performed by the discharge head 1 for manufacturing devices. In the present embodiment, it is provided in the +X direction from the stage device 2. The detection apparatus 30 detects a discharge nozzle (non-performing nozzle) that cannot discharge droplets due to clogging or the like, by detecting whether a droplet of liquid material is discharged from each of the plurality of  
15 discharge nozzles 11 installed in the discharge head 1. As a result, it is possible to detect whether a dot is missing from the substrate P when forming a dot pattern on the substrate by discharging droplets onto the substrate P.

The detection apparatus 30 is provided with a light emitter 31 for emitting detection light, and a receiver 32 capable of receiving detection light emitted from the  
20 light emitter 31. The light emitter 31 comprises a laser beam emitting device that emits a laser beam of a predetermined diameter. Furthermore, the droplet discharge apparatus IJ is provided with a display unit 40 that displays information related to detection results and detection conditions of the detection apparatus 30. The display unit 40 comprises for example a liquid crystal display, a CRT, or the like.

25 FIG. 4 is a schematic perspective view of the detection apparatus 30 with the

light emitter 31 and the receiver 32. As shown in FIG. 4, the light emitter 31 and the receiver 32 are arranged opposite each other. In the present embodiment, the light emitter 31 emits a laser beam, being a detection light, in the Y axis direction. The beam of the detection light is set to a diameter D, and the detection light emitted from the light emitter 31 travels straight toward the receiver 32. The discharge head 1 discharges droplets from above the light path of the detection light (on the +Z side), while being moved by drive of the moving device 4 in a direction (the X axis direction) that intersects the light path direction (the Y axis direction) of the detection light at a constant speed. The arrangement is such that droplets are discharged from the discharge nozzles 11 of the discharge head 1 at a determined time interval, and the droplets discharged from the discharge nozzles 11 pass through the optical path of the detection light.

FIG. 5 is a schematic diagram showing how droplets discharged from the discharge nozzles 11 of the discharge head 1 pass through the optical path of a detection light. The discharge head 1 shown in FIG. 5 has discharge nozzles 11A, 11B and 11C, which are aligned in the X axis direction, being the direction of movement. However, the number of discharge nozzles 11 arranged in the discharge head 1 can be optionally set.

As shown in FIG. 5, the discharge head 1 discharges droplets from each of the discharge nozzles 11A to 11C while moving in the X axis direction at a constant speed. The alignment of the discharge nozzles 11A to 11C, and the direction of movement of the discharge head 1 are the same. Droplets are discharged from each of the discharge nozzles 11A to 11C at the same time. Furthermore, each of the discharge nozzles 11A to 11C discharges a droplet at a constant time interval. The discharged droplets pass through the optical path of the detection light, being a light beam. Droplets pass through the optical path of the detection light, and the droplets are arranged on the optical

path of this detection light, thus the intensity of detection light received by the receiver 32 changes relative to the intensity of light received in a situation where there is no droplet placed on the light path of the detection light. That is, by placing droplets on the light path of the detection light, the intensity of light received in the receiver 32 falls compared with the case where no droplet is placed on the light path of the detection light. The received light result (received light signal) of the receiver 32 is output to the control unit CONT. The control unit CONT can determine whether there is a droplet discharged from a discharge nozzle 11 or not, based on the change (fall) in the intensity of the detection light received in the receiver 32, caused by a droplet passing through the optical path of the detection light.

To be specific, when a droplet is placed on the optical path of the detection light, the output signal (output voltage) of the receiver 32 changes when the intensity of light received in the receiver 32 falls. The receiver 32 outputs either one of a binary “HIGH” or “LOW” signal based on this output voltage to the control unit CONT. Here, for example, the receiver 32 may output a “HIGH” signal in the case where droplets are situated on the optical path of the detection light, and output a “LOW” signal where droplets are not situated on the optical path of the detection light.

If  $D$  is the diameter of the beam of the detection light,  $d$  is the diameter of the droplets discharged from the discharge nozzle 11,  $L$  is the distance between the discharge nozzles in the direction of movement of the discharge head 1, and  $H$  is the distance that the discharge head 1 moves from when a discharge nozzle discharges a droplet to when it discharges the next droplet, the detection apparatus 30 is set so as to satisfy the conditions

$$D/2 + d/2 \leq L \dots (1), \text{ and}$$

$$H \leq D \dots (2).$$

The distance H, as in the schematic diagram shown in FIG. 6, is the distance that the discharge head 1 moves from when a first droplet is discharged from, for example, a discharge nozzle 11B of the discharge head 1, which moves at a constant speed, to when a second droplet, being the next droplet to the first droplet, is discharged after a  
5 predetermined time interval.

By satisfying the above conditions, only one droplet discharged from the discharge nozzles 11 (11A to 11C) is placed on the optical path of the detection light, so that it is possible to detect accurately whether droplets are discharged correctly from the discharge nozzles. That is, in the case where the condition of the above equation (1) is  
10 not satisfied, a state occurs whereby two droplets discharged for example from the discharge nozzle 11A and the discharge nozzle 11B, are placed on the optical path of the detection light. Therefore, even in a state where the discharge nozzle 11A, which is not operating due to clogging or the like, does not discharge a droplet, and a droplet is discharged only from the discharge nozzle 11B, since the receiver 32 is constructed to  
15 output either one of the binary "HIGH" or "LOW" signals, it outputs a "HIGH" signal due to the droplet from the discharge nozzle 11B being present on the optical path of the detection light, even though a droplet has not been discharged from the discharge nozzle 11A. Hence there is a problem in that the control unit CONT makes an incorrect determination that "a droplet is discharged from the discharge nozzle 11A. However, by  
20 satisfying the above equation (1), then in a state where for example a droplet from the discharge nozzle 11A passes through the optical path of the detection light, a droplet from the discharge nozzle 11B passes outside the optical path of the detection light, so that the abovementioned problem can be avoided.

Furthermore, in the case where the above equation (2) is not satisfied, even  
25 though for example the discharge nozzle 11B discharges normally at a predetermined

time interval, a state occurs in FIG. 6 where the first droplet passes outside in the -X direction of the optical path of the detection light, and the second droplet also passes outside in the +X direction of the detection light. That is, even though droplets are discharged from the discharge nozzle 11B normally at a predetermined time interval,

5 neither the first droplet nor the second droplet passes through the optical path of the detection light. In other words, the discharge nozzle 11B has already passed through the optical path of the detection light when the second droplet is discharged. Hence there is a defect in that the receiver 32 cannot detect that droplets are discharged. However, by satisfying the condition of the above equation (2), droplets discharged normally at a

10 predetermined time interval pass through the optical path of the detection light, so that the abovementioned defect can be avoided.

Next is a description of a method of detecting whether droplets are discharged from the discharge nozzles 11 (11A to 11C) using a detection apparatus 30 having the above-described construction.

15 Firstly, the control unit CONT moves the discharge head 1 by means of the moving device 4, to the location where the operation of detecting non-performing nozzles is carried out, that is, in the vicinity of the detection apparatus 30. The control unit CONT then emits detection light toward the receiver 32 from the light emitter 31, and moves this discharge head 1 in a direction to intersect the optical path of the

20 detection light at a constant speed while matching the alignment of the plurality of discharge nozzles 11A to 11C with the direction of movement of the discharge head 1, discharging droplets from each of the discharge nozzles 11A to 11C at a constant time interval. An output signal from the receiver 32 is output to the control unit CONT, and the control unit CONT processes the output signal from the receiver 32. The control

25 unit CONT detects whether a droplet is being discharged from each of the discharge

nozzles 11A to 11C, based on changes in the intensity of detection light received by the receiver 32 due to droplets passing through the optical path of the detection light.

If the detection apparatus 30 determines that the conditions in the above equations (1) and (2) are not satisfied, the control unit CONT adjusts at least one of the value of the diameter D of the beam of the detection light, the diameter d of the droplet, and the distance H, in order to satisfy the above conditions. In the case of changing the diameter D of the beam of the detection light, the control unit CONT can adjust the diameter D by, for example, placing an optical element (lens or pin hole) in the vicinity of the detection light emitting section of the light emitter 31 using a drive unit, which is not shown in the figure. Furthermore, in the case of changing the diameter d of the droplet, the control unit CONT can adjust the diameter d by, for example, adjusting the oscillation amplitude of the piezoelectric element 20 of the discharge head 1 (by adjusting the drive voltage of the discharge head 1) to control the amount discharged in one droplet. Moreover, in the case of changing the distance H, the control unit CONT can adjust the distance H by, for example, adjusting the speed at which the discharge head 1 is moved by the moving device 4, or by adjusting the time interval at which droplets are discharged from the discharge nozzles 11A to 11C.

If, based on the detection results from the detection apparatus 30, it is determined that there is no non-performing nozzle that cannot discharge droplets among the plurality of discharge nozzles 11A to 11C, the control unit CONT terminates the series of processing regarding the detection of discharge nozzles, moves the discharge head 1 to the stage device 2 (the location where droplets are discharged for manufacturing devices), and discharges droplets of liquid material from the discharge head 1 onto the substrate P supported by the stage device 2. On the other hand, if it is determined that there is a non-performing nozzle, based on the detection results from the

detection apparatus 30, the control unit CONT cleans this discharge head 1 using for example the cleaning unit 6 as shown in FIG. 1.

As described above, by setting the conditions shown in the above equations (1) and (2) regarding a detection apparatus that detects optically whether a droplet is discharged from a discharge nozzle 11, it is possible to place only one droplet discharged from each of the discharge nozzles 11A to 11C on the optical path of a detection light. Consequently, it is possible to detect correctly whether a droplet is discharged normally from the discharge nozzles 11A to 11C.

In the above embodiment, the diameter D is the diameter of the beam of a detection light. However, in the case where the diameter of the beam of the detection light is greater than or equal to the diameter of the circular measurement region, the diameter D of the above equations (1) and (2) denotes the diameter of the measurement region. That is, as shown in the schematic diagram in FIG. 7, in the case where a diameter D1 of the beam of the detection light is greater than or equal to a diameter D2, being the measurement region of the receiver 32, then if a droplet passes through a region AR, being part of the optical path of the detection light, when the region AR passed through is a region outside of the measurement region of the receiver 32, the receiver 32 cannot detect the passing droplet. Therefore, in the case where the diameter D1 of the beam of a detection light is greater than or equal to the diameter D2 of the measurement region, “diameter D in the above conditional expression = diameter D2 of the measurement region”. On the other hand, in the case where the diameter D of the beam of a detection light is less than or equal to the diameter D2 of the measurement region of the receiver 32, “diameter D in the above conditional expression = diameter D1 of the beam of the detection light”.

FIG. 1 shows only one discharge head 1 and the stage device 2. However, the

droplet discharge apparatus IJ may comprise a plurality of discharge heads 1 and stage devices 2. In this case, droplets of different types or the same type of liquid material may be discharged from the plurality of discharge heads 1. After a first liquid material is discharged from a first discharge head of the plurality of discharge heads 1 onto the substrate P, it is baked or dried, and then after a second liquid material is discharged from a second discharge head onto the substrate P, it is baked or dried. Hereunder, by performing the same process using the plurality of discharge heads, a plurality of material layers is stacked on the substrate P to form a multilayer pattern.

FIG. 8 shows an example of a process for manufacturing devices by a droplet discharge apparatus IJ of the present invention, showing an example of a process for manufacturing color filters of liquid crystal devices.

Firstly, as shown in FIG. 8A, black matrices 52 are formed on one surface of the transparent substrate P. For a method of forming the black matrices 52, resin (preferably black) with no optical transparency is coated at a prescribed thickness (for example, approximately  $2\mu\text{m}$ ) by a method such as spin coating or the like. For minimum display elements surrounded by the grid of black matrices 52, that is, filter elements 53, for example the width in the X axis direction is approximately  $30\mu\text{m}$ , and the length in the Y axis direction is approximately  $100\mu\text{m}$ .

Next, as shown in FIG. 8B, a liquid material (droplet) 54 for a color filter is discharged from the discharge apparatus, and this lands on the filter element 53. The amount of liquid material 54 discharged should be a sufficient amount considering the reduction in the volume of liquid material during heating treatment.

When the droplets 54 fill all filter elements 53 on the substrates P in this manner, heating treatment is performed using a heater such that the substrate P reaches a prescribed temperature (for example, approximately  $70^{\circ}\text{C}$ ). By this heating treatment,

solvent evaporates from the liquid material, so that the volume of the liquid material is reduced. In the case where this volume reduction is extreme, the droplet discharge process and heating treatment are repeated until a sufficient color filter film thickness is obtained. By this process, solvent contained in the liquid material evaporates, and only solids (functional material) contained in the liquid material remain to form the final film, forming color filters 55 as shown in FIG. 8C.

Next as shown in FIG. 8D, in order to make the substrate P smooth, and to protect the color filters 55, the color filters 55 and the black matrices 52 are covered by forming a protective film 56 on the substrate P. When forming this protective film 56, a method such as spin coating, roll coating, ripping or the like can be used. However, similarly to the case of the color filters 55, it may also be formed using the discharge apparatus.

Next as shown in FIG. 8E, a transparent conductive film 57 is formed over the whole surface of this protective film 56 using a sputtering technique, a vacuum evaporation method or the like. Afterwards, the transparent conductive film 57 is patterned, and pixel electrodes 58 are patterned corresponding to the filter elements 53. In a case where TFTs (Thin Film Transistors) are used to drive a liquid crystal display panel, this patterning is not required.

In such color filter manufacturing, since the discharge head 1 is used, it is possible to discharge color filter material continuously without problems. Thus it is possible to form good color filters as well as improving the productivity.

Before the above-described color filter manufacturing process, a detection process is performed to verify whether droplets are discharged from the discharge nozzles 11 of the discharge head 1.

Furthermore, in the discharge apparatus, it is possible to form optional system

components of electro-optical devices by selecting appropriate liquid material. For example, by using for the liquid, a range of materials such as; material for forming organic EL elements, metal colloids which become material for metal wiring, or microlens material, liquid crystal material and the like, it is possible to form various system components constituting electro-optical devices. Alternatively, it is also possible to form a SED (Surface-Conduction Electron-Emitter Display) as an electro-optical device.

Hereunder is a description of a manufacturing method for an electro-optical device using the above-described droplet discharge apparatus IJ.

10 Firstly, a manufacturing method for an organic EL device will be described as an example of forming a system component of an electro-optical device.

FIG. 9 is a sectional side elevation of an organic EL device which constitutes part of a system component manufactured using the discharge apparatus. Firstly, a structural outline of this organic EL device will be described. The organic EL device formed here is an embodiment of an electro-optical device of the present invention.

15 An organic EL device 301 as shown in FIG. 9 is one where an organic EL element 302 comprising; a substrate 311, a circuit element section 321, pixel electrodes 331, bank sections 341, light emitting diodes 351, a cathode 361 (counter electrode), and a sealing substrate 371, is connected by the wiring of a flexible substrate (omitted from the figure) to a drive IC (omitted from the figure). The circuit element section 321 is formed on the substrate 311, and a plurality of pixel electrodes 331 is arranged in a line on the circuit element section 321. The bank sections 341 are formed in a grid shape between the pixel electrodes 331, and light emitting diodes 351 are formed in concave apertures 344 formed by the bank sections 341. The cathode 361 is formed over the whole surface of the bank sections 341 and the light emitting diodes 351, and the sealing

20

25

substrate 371 is laminated onto the cathode 361.

The manufacturing process for an organic EL device 301 containing the organic EL element has a bank section forming process for forming the bank sections 341, a plasma processing process for forming the light emitting diodes 351 appropriately, a light emitting diode forming process for forming the light emitting diodes 351, a counter electrode forming process for forming the cathode 361, and a sealing process for laminating the sealing substrate 371 onto the cathode 361 for sealing.

The light emitting diode forming process forms the light emitting diodes 351 by forming a hole injection layer 352 and a luminous layer 353 in the concave apertures 344, namely on the pixel electrodes 331, and comprises a hole injection layer forming process and a luminous layer forming process. The hole injection layer forming process has a first discharge process for discharging a first component (droplet) to form the hole injection layer 352 on the pixel electrodes 331, and a first drying process for drying the discharged first component to form the hole injection layer 352. The luminous layer forming process has a second discharge process for discharging a second component (droplet) to form the luminous layer 353 on the hole injection layer 352, and a second drying process for drying the discharged second component to form the luminous layer 353.

In this light emitting diode forming process, the droplet discharge apparatus IJ is used in the first discharge process in the hole injection layer forming process, and the second discharge process in the luminous layer forming process.

In this organic EL device 301 also, by verifying the discharge operation of the discharge head 1 in advance prior to discharge for forming each system component, it is possible to discharge forming material of the hole injection layer and forming material of the luminous layer from the discharge head 1 satisfactorily. Therefore, it is possible to

improve the reliability of the organic EL device 301 obtained.

Next is a description of a manufacturing method for a plasma display as an example of forming a system component.

FIG. 10 is an exploded perspective view showing a plasma display, being a system component, parts of which, namely address electrodes 511 and bus electrodes 512a, are manufactured by the droplet discharge apparatus IJ. In FIG. 10, reference numeral 500 denotes a plasma display. This plasma display 500 basically comprises a glass substrate 501, a glass substrate 502, and an electrical discharge display section 510 formed therebetween.

The electrical discharge display section 510 is assembled with a plurality of electrical discharge chambers, which are arranged such that a set of three electrical discharge chambers 516 forms one pixel, being a red electrical discharge chamber 516 (R), a green electrical discharge chamber 516 (G), and a blue electrical discharge chamber 516 (B).

The address electrodes 511 are formed in strips at a predetermined spacing on the surface of the (glass) substrate 501, and a dielectric layer 519 is formed so as to cover the surfaces of the address electrodes 511 and the substrate 501. Furthermore, partitions 515 are formed on the dielectric layer 519 between the address electrodes 511, parallel with the address electrodes 511. The partitions 515 are also divided (omitted from the figure) at predetermined locations in their longitudinal direction, perpendicular to the address electrodes 511. Basically, rectangular regions are formed, divided by adjacent partitions on the left and right sides in the widthwise direction of the address electrodes 511, and partitions arranged perpendicular to the address electrodes 511, forming electrical discharge chambers 516 corresponding to the rectangular regions, and a set of three rectangular regions constitutes one pixel. Furthermore, fluorescent substances 517

fill the rectangular regions divided by the partitions 515. The fluorescent substances 517 fluoresce with any one of red, green and blue emissions: a red fluorescent substance 517 (R) fills the bottom of the red electrical discharge chamber 516 (R), a green fluorescent substance 517 (G) the bottom of the green electrical discharge chamber 516 (G), and a blue fluorescent substance 517 (B) the bottom of the blue electrical discharge chamber 516 (B).

Next, transparent display electrodes 512 formed from a plurality of ITOs are formed on the glass substrates 502 in strips at a predetermined spacing, perpendicular to the address electrodes 511, and the bus electrodes 512a are formed from metal in order to compensate for the high resistance ITO. Furthermore, a dielectric layer 513 is formed over them, and a protective film 514 is formed from MgO.

The two substrates, the substrate 501 and the glass substrate 502, are then glued facing each other such that the address electrodes 511 and the display electrodes 512 cross perpendicular to each other, and the electrical discharge chambers 516 are formed by evacuating the air enclosed by the substrate 501 and the partitions 515, and the protective film 514 formed on the glass substrate 502 side, and then introducing rare gas. The display electrodes 512 formed on the glass substrate 502 side are formed in an arrangement such that there are two of them to each electrical discharge chamber 516.

The address electrodes 511 and the display electrodes 512 are connected to AC power, which is not shown in the figure, and by passing an electric current between the electrodes, it is possible to cause excitation-emission from the fluorescent substances 517 for color display at a required location in the electrical discharge display section 510.

In the present example, especially the address electrodes 511, the bus electrodes 512a and the fluorescent substances 517 are formed using the droplet discharge apparatus II. That is, especially because of the advantage in patterning, the address electrodes 511

and the bus electrodes 512a are formed by discharging liquid material (droplet) consisting of a dispersion of metal colloid material (for example, gold colloid and silver colloid) and conductive particles (for example, metal microparticles), and then drying and baking this. Furthermore, the fluorescent substances 517 are also formed by  
5 discharging liquid material (droplet) in which a fluorescent substance is held in solution or dispersed in a dispersion medium, and then drying and baking this.

In manufacturing this plasma display 500, prior to the discharge for forming the address electrodes 511, the bus electrodes 512a, and the fluorescent substances 517, by verifying the discharge operation of the discharge head 1 in advance, it is possible to  
10 discharge both the material (liquid material) for forming the electrodes 511 and 512a, and the material (liquid material) for forming the fluorescent substances 517, satisfactorily. Therefore, it is possible to improve the reliability of the plasma display 500 obtained.

Next is a description of a method of forming a conductive film wiring pattern (metal wiring pattern) as an example of forming the above-described system components.

15 FIG. 11 is a flow chart showing an example of a method of forming a conductive film wiring pattern.

In FIG. 11, the method of forming a pattern according to the present example has a step (step S1) for cleaning a substrate on which droplets of liquid material (droplet) are to be placed using a predetermined solvent or the like, a liquid repellency treatment  
20 step (step S2) which comprises part of a substrate surface processing step, a liquid repellency control processing step (step S3), which comprises part of a surface processing step, for adjusting the liquid sputtering of a substrate surface in which a liquid sputtering process is applied, a material placement step (step S4) for placing droplets of liquid material containing conductive film wiring forming material on the surface treated  
25 substrate, based on the droplet discharge method to draw (form) a film pattern, an

intermediate drying treatment step (step S5) containing thermal and optical treatment which removes at least part of the solvent component of the liquid material placed on the substrate, and a baking step (step S7) for baking the substrate on which a predetermined pattern is drawn. After the intermediate drying treatment step, it is determined whether the predetermined pattern drawing is completed (step S6), and if the pattern drawing is completed, the baking step is performed. However, if the pattern drawing is not completed, the material placement step is performed.

Next is a description of the material placement step (step S4) based on a droplet discharge method by means of the droplet discharge apparatus IJ.

The material placement step of the present example is a step for forming a plurality of line shaped film patterns (wiring patterns) side by side on the substrate P by placing droplets of liquid material containing conductive wire forming material on the substrate P from the droplet discharge head 1 of the droplet discharge apparatus IJ. The liquid material is a liquid in which conductive particles of metal or the like, being conductive wire film forming material, are dispersed in a dispersion medium. In the following description, a case is described in which first, second and third film patterns (line patterns), W1, W2 and W3 are formed on the substrate P.

FIG. 12, FIG. 13 and FIG. 14 are diagrams to describe an example of the order of arranging droplets on the substrate P in the present example. In the figures, a bitmap of pixels, being a plurality of grid shaped unit regions, where droplets of liquid material are placed, is arranged on the substrate P. Here, each square represents one pixel. First, second, and third pattern forming regions R1, R2 and R3, which form the first, second and third film patterns W1, W2 and W3, are arranged so as to correspond to predetermined pixels among the plurality of pixels. The plurality of pattern forming regions R1, R2 and R3 is arranged side by side in the X axis direction. In FIG. 12 to

FIG. 14, the pattern forming regions R1, R2 and R3 are the hatched regions.

Furthermore, the arrangement is such that droplets of liquid material discharged from the first discharge nozzle 11A of the plurality of discharge nozzles provided on the discharge head 1 of the droplet discharge apparatus IJ are placed on the first pattern forming region R1 on the substrate P. Similarly, the arrangement is such that droplets of liquid material discharged from the second and third discharge nozzles 11B and 11C of the plurality of discharge nozzles provided on the discharge head 1 of the droplet discharge apparatus IJ are placed on the second and third pattern forming regions R2 and R3 on the substrate P respectively. That is, the discharge nozzles 11A, 11B and 11C are arranged so as to correspond to the first, second and third pattern forming regions R1, R2 and R3 respectively. The discharge head 1 places a plurality of droplets onto a plurality of pixels in the arranged plurality of pattern forming regions R1, R2 and R3 sequentially.

Moreover, the arrangement is such that in the first, second and third pattern forming regions R1, R2 and R3, the first, second and third film patterns W1, W2 and W3 to be formed in the pattern forming regions R1, R2 and R3 are formed starting with a first side pattern Wa on one side (-X side) in the line width direction, then a second side pattern Wb on the other side (+X side), and after forming the first and second side patterns Wa and Wb, a central pattern Wc.

In the present example, the film patterns (line patterns) W1 to W3, and the pattern forming regions R1 to R3, each have the same line width L, and this line width L is set to be the size of three pixels. Furthermore, the spacing between patterns is set to be the same width S, and this width S is also set to be the size of three pixels. The nozzle pitch, being the spacing between the discharge nozzles 11A to 11C, is set to be the size of six pixels.

In the following description, the discharge head 1 with discharge nozzles 11A,

11B and 11C discharges droplets while scanning the substrate P in the Y axis direction.

In the description using FIG. 12 to FIG. 14, a droplet placed during a first scan is designated "1", and droplets placed during second, third, ...,  $n^{\text{th}}$  scans are designated "2", "3", ..., "n" respectively.

5           As shown in FIG. 12A, in the first scan, droplets are placed from the first, second and third discharge nozzles 11A, 11B and 11C at the same time in the predetermined first side pattern forming regions in order to form the first side patterns Wa on the first, second and third pattern forming regions R1, R2 and R3, with a one pixel gap between droplets. When droplets are discharged from the discharge nozzles 11A, 10 11B and 11C, the discharge operation of the discharge head 1 is verified in advance prior to the discharge. Here, the droplets placed on the substrate P spread out over the substrate P when they reach the substrate P. That is, as shown by the circles in FIG. 12A, droplets landing on the substrate P spread out to have a diameter C larger than one pixel. Since the droplets are placed at a predetermined spacing (one pixel spacing) in 15 the Y axis direction, the droplets on the substrate P are placed so as not to overlap. By so doing, it is possible to avoid applying excessive liquid material onto the substrate P in the Y axis direction, thus preventing bulges from occurring.

In FIG. 12A, the droplets are arranged so as not to overlap each other when placed on the substrate P. However, the arrangement may be such that the droplets are 20 overlapped slightly. Furthermore, the droplets are placed with a one pixel gap between them. However, the droplets may be placed with a gap of any desired number of two or more pixels. In this case, the number of scanning operations and placement operations (discharge operations) of the discharge head 1 on the substrate P may be increased to fill in the droplets on the substrate.

25           Moreover, since the surface of the substrate P is treated to be liquid repellent as

required by steps S2 and S3, excess spreading of droplets placed on the substrate P is suppressed. As a result, it is possible to maintain a satisfactory pattern shape reliably, and it is also easy to form thick films.

FIG. 12B is a schematic diagram when droplets are placed on the substrate P from the discharge head 1 in a second scan. In FIG. 12B, droplets placed during the second scan are designated "2". During the second scan, droplets are placed by the discharge nozzles 11A, 11B and 11C at the same time so as to interpose between the droplets "1" placed during the first scan. The droplets from the first and second scans and placement operations merge together to form first side patterns Wa in the first, second and third pattern forming regions R1, R2 and R3. Here, the droplets "2" also spread out when they land on the substrate P, and parts of the droplets "2" and parts of the droplets "1" placed on the substrate P previously overlap. To be specific, parts of the droplets "2" overlap the droplets "1". In addition, during the second scan, when discharging droplets from the discharge nozzles 11A, 11B and 11C, the discharge operation of the discharge head 1 can be verified in advance prior to the discharge.

In order to remove the dispersion medium after placing the droplets for forming the first side patterns Wa on the substrate P, it is possible to perform an intermediate drying process (step S5) as required. The intermediate drying process may be an optical process using lamp anneal, as well as typical heating treatment using a heating system such as a hot plate, an electric furnace, a hot gas generator, or the like.

Next, the discharge head 1 and the substrate P move relative to each other in the X axis direction by the size of two pixels. Here, the discharge head 1 is stepped in the +X direction by two pixels with respect to the substrate P. At the same time, the discharge nozzles 11A, 11B and 11C move. Then, the discharge head 1 performs a third scan. As a result, as shown in FIG. 13A, droplets "3" for forming second side patterns

Wb, forming parts of the film patterns W1, W2 and W3, are placed on the substrate P by the discharge nozzles 11A, 11B and 11C at the same time with a gap from the first side patterns Wa in the X axis direction. The droplets “3” are also placed with a gap of one pixel in the Y axis direction. In addition, during the third scan, when discharging

5 droplets from the discharge nozzles 11A, 11B and 11C, the discharge operation of the discharge head 1 can be verified in advance prior to the discharge.

FIG. 13B is a schematic diagram when droplets are placed on the substrate P from the discharge head 1 in a fourth scan. In FIG. 13B, droplets placed during the fourth scan are designated “4”. During the fourth scan, droplets are placed by the

10 discharge nozzles 11A, 11B and 11C at the same time so as to interpose between the droplets “3” placed during the third scan. The droplets from the third and fourth scans and placement operations merge together to form second side patterns Wb in the pattern forming regions R1, R2 and R3. Here, parts of the droplets “4”, and parts of the droplets “3” placed on the substrate P previously overlap. To be specific, parts of the

15 droplets “4” overlap the droplets “3”. In addition, during the fourth scan, when discharging droplets from the discharge nozzles 11A, 11B and 11C, the discharge operation of the discharge head 1 can be verified in advance prior to the discharge.

Here also, in order to remove the dispersion medium after placing the droplets for forming the second side patterns Wb on the substrate P, it is possible to perform an

20 intermediate drying process as required.

Next, the discharge head 1 is stepped in the -X direction by one pixel with respect to the substrate P, and at the same time, the discharge nozzles 11A, 11B and 11C move in the -X direction by one pixel. Then, the discharge head 1 performs a fifth scan. As a result, as shown in FIG. 14A, droplets “5” for forming central patterns Wc, forming

25 parts of the film patterns W1, W2 and W3, are placed on the substrate at the same time.

Here, parts of the droplets “5” and parts of the droplets “1” and “3” placed on the substrate P previously overlap. To be specific, parts of the droplets “5” overlap the droplets “1” and “3”. In addition, during the fifth scan, when discharging droplets from the discharge nozzles 11A, 11B and 11C, the discharge operation of the discharge head 1  
5 can be verified in advance prior to the discharge.

FIG. 14B is a schematic diagram when droplets are placed on the substrate P from the discharge head 1 in a sixth scan. In FIG. 14B, droplets placed during the sixth scan are designated “6”. During the sixth scan, droplets are placed by the discharge nozzles 11A, 11B and 11C at the same time so as to interpose between the droplets “5”  
10 placed during the fifth scan. The droplets from the fifth and sixth scans and placement operations merge together to form central side patterns Wc in the pattern forming regions R1, R2 and R3. Here, parts of the droplets “6” and parts of the droplets “5” placed on the substrate P previously overlap. To be specific, parts of the droplets “6” overlap the droplets “5”. Furthermore, parts of the droplets “6” overlap the droplets “2” and “4”  
15 placed on the substrate P previously. In addition, during the sixth scan, when discharging droplets from the discharge nozzles 11A, 11B and 11C, the discharge operation of the discharge head 1 can be verified in advance prior to the discharge.

As above, the film patterns W1, W2 and W3 are formed in the pattern forming regions R1, R2 and R3.

20 As described above, when placing a plurality of droplets sequentially in the pattern forming regions R1, R2 and R3 to form almost identically shaped film patterns W1, W2 and W3, since the order of placing droplets in the plurality of pixels of the pattern forming regions R1, R2 and R3 is set to be the same, then even in the case where the droplets “1” to “6” are placed so as to overlap parts of each other, the shapes of the  
25 overlaps in the film patterns W1, W2 and W3 are identical. Therefore, it is possible to

make the appearance of the film patterns W1, W2 and W3 identical. Accordingly, it is possible to prevent the occurrence of unevenness in appearance between the film patterns W1, W2 and W3.

Moreover, since the placement order of droplets is the same in the film patterns W1, W2 and W3, the arrangements of droplets (overlapping shapes among droplets) in the film patterns W1, W2 and W3 are identical. Hence it is possible to prevent the occurrence of unevenness in appearance.

Furthermore, since the overlapping states between the film patterns W1, W2 and W3 are set to be the same, it is possible to make the film thickness distribution of the film patterns almost the same. Accordingly, in a case where this film pattern is a repeating pattern that repeats across the surface of the substrate, to be specific, in a case where a plurality of patterns is provided corresponding to pixels in a display device, the pixels have the same film thickness distribution. Accordingly, it is possible for locations across the surface of the substrate to exhibit the same functionality.

Moreover, since the droplets “5” and “6” for forming the central patterns Wc are placed after forming the first and second side patterns Wa and Wb so as to fill up the spaces between them, it is possible to form the line width of the film patterns W1, W2 and W3 almost uniformly. That is, in a case where the droplets “1”, “2”, “3” and “4” for forming the side patterns Wa and Wb are placed after forming the central patterns Wc on the substrate P, a phenomena occurs whereby these droplets are drawn toward the central patterns Wc formed on the substrate P previously. Therefore there is a case in which the line widths of the film patterns W1, W2 and W3 are difficult to control.

However, since the droplets “5” and “6” for forming central patterns Wc are placed after forming the side patterns Wa and Wb on the substrate P previously, so as to fill up the spaces between them as in the present embodiment, it is possible to control the line width

of the film patterns W1, W2 and W3 accurately.

The side patterns Wa and Wb may be formed after forming the central patterns Wc. In this case, by using the same placement order of droplets for the film patterns W1, W2 and W3, it is possible to prevent the occurrence of differences in appearance.

5        When forming a conductive wire film pattern (metal wire pattern) in this way, by verifying the discharge operation of the discharge head 1 in advance prior to discharge, droplets can be discharged satisfactorily. Thus it is possible to improve the reliability of the conductive wire pattern obtained.

Next is a description of a method of manufacturing a microlens as an example of  
10    forming a system component.

In the present example, as shown in FIG. 15A, a droplet 622a formed from a light transmissive resin is applied by discharge onto a substrate P from the discharge head 1 of the droplet discharge apparatus IJ. When the droplet 622a is discharged from the discharge head 1, the discharge operation of the discharge head 1 is verified in advance  
15    prior to the discharge.

In the case where the microlens to be obtained is used for an optical film for a screen for example, the substrate P may be a light transmissive sheet or light transmissive film, formed from a cellulose resin such as cellulose acetate, propylcellulose, or the like, or a transparent resin (light transmissive resin) such as polyvinyl chloride, polyethylene, polypropylene, polyester, or the like. Furthermore, a substrate formed from transparent  
20    material (light transmissive material) such as glass, polycarbonate, polyallylate, polyether sulphone, amorphous polyolefin, polyethylene terephthalate, polymethyl methacrylate, or the like, can also be used as a substrate.

A light transmissive resin may be an acrylic resin such as polymethyl  
25    methacrylate, polyhydroxy ethyl methacrylate, poly cyclohexyl methacrylate, or the like,

an allyl resin such as polydiethyleneglycol bis allyl carbonate, polycarbonate, or the like, or thermoplastic or thermosetting resin such as methacrylic resin, polyurethane resin, polyester resin, polyvinyl chloride resin, polyvinyl acetate resin, cellulose resin, polyamide resin, fluororesin, polypropylene resin, or polystyrene resin. Either one of these types may be used, or a plurality of these types may be mixed for use.

However, in the present example, specifically, a radiated light irradiation curing type is used for the light transmissive resin. This radiated light irradiation curing type is a combination of a light transmissive resin and a photoinitiator such as biimidazole compound, or the like, and the irradiation curing characteristic is obtained by the combination with such a photoinitiator. Radiated light is a general name for visible light, ultraviolet light, far ultraviolet light, X-rays, an electron beam, and the like, and especially ultraviolet light is used typically.

Depending on the size of a desired single microlens, one or more droplets 622a of such irradiation curing type light transmissive resin are discharged onto a substrate P. Then, the light transmissive resin 623 formed from the droplets 622a becomes a convex shape (almost hemispherical) as shown in FIG. 15A due to its surface tension. In this manner, a predetermined amount of light transmissive resin is applied by discharge as a single microlens to be formed, and this coating process is repeated for the desired number of microlenses. Then a radiated light such as ultraviolet light or the like is radiated onto the light transmissive resin 623 to cure it as shown in FIG. 15B to form a hardened body 623a. Here, the capacity of the droplet 622a discharged from the discharge head 1 per drop depends on the discharge head 1 and the ink material to be discharged. However, normally it is approximately 1pL to 20pL.

Next, as shown in FIG. 15C, a desired number of droplets 622b, in which a large number of minute light diffusible particles 626 is dispersed, is discharged from the

discharge head 1, and adheres to the surfaces of the hardened bodies 623a. The minute light diffusible particles include minute particles of silica, alumina, titania, calcium carbonate, aluminum hydroxide, acrylic resin, organic silicon resin, polystyrene, urea resin, formaldehyde condensation product, and the like, and one or a plurality of these types is used. However, in order for the minute light diffusible particles 626 to exhibit sufficient light diffusivity, in the case where the minute particles are optically transparent, it is necessary to have a sufficient difference between their refractive index and the refractive index of the light transmissive resin mentioned previously. Accordingly, in the case where the minute light diffusible particles 626 are optically transparent, appropriate ones are selected for use based on the light transmissive resin to be used so as to satisfy such a condition.

Such minute light diffusible particles 626 are prepared as an ink capable of being discharged from the discharge head 1, by being dispersed in an appropriate solvent (for example, a solvent used for light transmissive resin) in advance. At this time, it is desirable that dispersion of the minute light diffusible particles 626 in the solvent is improved by coating the surface of the minute light diffusible particles 626 with a surface active agent, or by coating them with a molten resin. By performing such treatment, it is possible to add flowability to the minute light diffusible particles 626, which aids good discharge from the discharge head 1. As a surface active agent for the surface treatment, one such as cationic system, an anionic system, a nonionic system, an amphoteric, a silicon system, a fluoro resin system or the like, is appropriately selected for use based on the type of minute light diffusible particles 624.

Furthermore, it is desirable to use minute light diffusible particles 626 with a particle size of greater than or equal to 200nm and less than or equal to 500nm. This is because in such a range, the optical transparency can be maintained satisfactorily by a

particle size of 200nm or greater, and it can be discharged from nozzles of the discharge head 1 satisfactorily by being 500nm or less.

The same discharge head 1 as the one that discharges the droplet 622a of light transmissive resin may be used to discharge the droplets 622b in which minute light  
5 diffusible particles 626 are dispersed, or a different one may be used. In the case where the same one is used, it is possible to simplify the construction of the apparatus containing the discharge head 1. On the other hand, in the case where a different one is used, since each ink (ink formed from light transmissive resin and ink formed from minute light diffusible particles 624) uses its own head, it is not necessary to clean the  
10 heads or the like when changing the inks to be coated, thus enabling the productivity to be improved.

Afterwards, by performing heating treatment, decompression treatment, or heat and decompression treatment, the solvent in a droplet 622b, in which minute light diffusible particles 624 are dispersed, is evaporated. By so doing, the surface of the  
15 hardened body 623a is softened by the solvent in the droplet 622b, and since the minute light diffusible particles 626 are adhered to this, the minute light diffusible particles 624 are fixed onto the surface of the hardened body 623a of light transmissive resin as the solvent evaporates and the surface of the hardened body 623a is hardened again. By fixing the minute light diffusible particles 624 onto the surface of the hardened body  
20 623a in this manner, it is possible to obtain a microlens 625 of the present invention, formed by dispersing the minute light diffusible particles 624 on the surface as shown in FIG. 15D.

In such a method of manufacturing a microlens 625, it is also possible to discharge the droplets 622a and 622b satisfactorily by verifying the discharge operation  
25 of the discharge head 1 in advance, prior to the discharge. Accordingly, it is possible to

improve the reliability of the microlens 625 obtained.

Furthermore, since the convex shape (almost hemispherical) microlens 625 is formed from the light transmissive resin 623 and the minute light diffusible particles 624 using an ink jet method, no forming mold is required as in the case of using a metal pattern molding process or an injection molding process, and there is also less loss of material. Accordingly, it is possible to achieve a reduction in the manufacturing cost. Moreover, since the microlens to be obtained is a convex shape (almost hemispherical), by using this microlens it is possible to disperse light almost evenly over a wide angle range (direction) of 360° for example. Furthermore, since minute light diffusible particles 626 are incorporated, it is possible to obtain a microlens with high diffusivity.

Next is a description of a method of manufacturing an image display device with an electron emitting element as an example of forming a system component.

A substrate 70A as shown in FIG. 16A and FIG. 16B is to be made into an electron source substrate 70B of an image display device in which some of the system components are formed by a process using the above-described droplet discharge apparatus IJ. The substrate 70A has a plurality of discharge target sections 78, arranged in a matrix.

To be specific, the substrate 70A has a substrate 72, a sodium diffusion prevention layer 74, a plurality of device electrodes 76A and 76B, a plurality of metal wires 79A located on the plurality of device electrodes 76A, and a plurality of metal wires 79B located on the plurality of device electrodes 76B. The shapes of each of the plurality of metal wires 79A extend in the Y axis direction. The shapes of each of the plurality of metal wires 79B extend in the X axis direction. Since insulating films 75 are formed between the metal wires 79A and the metal wires 79B, the metal wires 79A and the metal wires 79B are electrically insulated.

Parts containing a pair of a device electrode 76A and a device electrode 76B correspond to one pixel region. The device electrode 76A and device electrode 76B in a pair oppose each other on the sodium diffusion prevention layer 74, with a predetermined distance therebetween. A device electrode 76A corresponding to a particular pixel region is connected electrically with a corresponding metal wire 79A. Furthermore, a device electrode 76B corresponding to the pixel region is connected electrically with a corresponding metal wire 79B. In the present specification, the part comprising the combination of the substrate 72 and the sodium diffusion prevention layer 74 may be designated a support substrate.

In each of the pixel regions of the substrate 70A, part of the device electrode 76A, part of the device electrode 76B, and the sodium diffusion prevention layer 74 exposed between the device electrode 76A and the device electrode 76B correspond to a discharge target section 78. To be more specific, the discharge target section 78 is a region where a conductive thin film 411F (refer to FIG. 17B) is to be formed, and the conductive thin film 411F is formed such that it covers part of the device electrode 76A, part of the device electrode 76B, and the gap between the device electrodes 76A and 76B. As shown by broken lines in FIG. 16B, the discharge target section 78 in the present example is circular.

The substrate 70A shown in FIG. 16B is positioned parallel to an imaginary plane defined by the X axis direction and the Y axis direction. The line writing direction and the columnwise direction of the matrices formed by a plurality of discharge target sections 78 are parallel to the X axis direction and the Y axis direction respectively. In the substrate 70A, the discharge target sections 78 are arranged side by side at intervals in this order in the X axis direction. Furthermore, the discharge target sections 78 are arranged side by side at a predetermined spacing in the Y axis direction.

The spacing LX between the discharge target sections 78 in the X axis direction is approximately 190 $\mu$ m. The spacing between the discharge target sections 78 and the above-described size of the discharge target section correspond to the spacing between pixel regions in an approximately 40 inch high-vision television.

5           The droplet discharge apparatus IJ discharges conductive thin film material 411 as liquid material (droplet) onto each of the discharge target sections 78 of the substrate 70A in FIG. 16A and FIG. 16B. An organic palladium solution is used for this conductive thin film material 411, for example.

10           In order to manufacture an image display device using the droplet discharge apparatus IJ, firstly, the sodium diffusion prevention layer 74 whose main component is silicon dioxide (SiO<sub>2</sub>) is formed on the substrate 72 formed from soda glass. To be specific, the sodium diffusion prevention layer 74 is obtained by forming a 1 $\mu$ m thick SiO<sub>2</sub> film on the substrate 72 using a sputtering technique. Next, a titanium layer with a thickness of 5nm is formed on the sodium diffusion prevention layer 74 by a sputtering  
15           technique or a vacuum evaporation method. Then, a plurality of pairs of device electrodes 76A and device electrodes 76B is formed from the titanium layer, with a predetermined distance therebetween, using a photolithographic technique and an etching method. Afterwards, a plurality of metal wires 79A extending in the Y axis direction is formed by coating and then baking silver (Ag) paste onto the sodium diffusion  
20           prevention layer 74 and the plurality of device electrodes 76A using a screen printing technique. Next, an insulating film 75 is formed by coating and baking a glass paste onto a part of each of the metal wires 79A using a screen printing technique. Then, a plurality of metal wires 79B extending in the X axis direction is formed by coating and baking Ag paste onto the sodium diffusion prevention layer 74 and the plurality of device  
25           electrodes 76B using a screen printing technique. In the case of manufacturing the

metal wires 79B, Ag paste is coated such that the metal wires 79B cross the metal wires 79A via the intervening insulating film 75. The substrate 70A as shown in FIG. 16A and FIG. 16B is obtained using the process described above.

Next, the substrate 70A is made to be lyophilic by an oxygen plasma process under atmospheric pressure. This process makes part of the surface of the device electrodes 76A, part of the surface of the device electrodes 76B, and the surface of the exposed support substrate between the device electrodes 76A and the device electrodes 76B lyophilic. Then, the surfaces become the discharge target sections 78. In addition, a surface that exhibits the desired lyophilic properties could be obtained without the above-described surface processing, depending on the material. In such a case, part of the surface of the device electrodes 76A, part of the surface of the device electrodes 76B, and the surface of the exposed support substrate between the device electrodes 76A and the device electrodes 76B become the discharge target sections 78 without performing the surface processing.

The substrate 70A on which the discharge target sections 78 are formed is carried to a stage of the droplet discharge apparatus IJ by a carrier device. Then, as shown in FIG. 17A, the droplet discharge apparatus IJ discharges a conductive thin film material 411 from a discharge head 1 so as to form a conductive thin film 411F on the discharge target sections 78. Here, when discharging the conductive thin film material 411, the discharge operation of the discharge head 1 is verified in advance prior to the discharge.

In the present example, discharge is performed from the discharge head 1 such that the diameter of the droplets of the conductive thin film material 411 landing on the discharge target sections 78 are within a range of 60 $\mu$ m to 80 $\mu$ m. When a layer of a conductive thin film material 411 is formed on all the discharge target sections 78 of the

substrate 70A, the carrier device places the substrate A in a drying device. Then, a conductive thin film 411F, whose main component is palladium oxide, is obtained on the discharge target sections 78 by drying the conductive thin film material 411 on the discharge target sections 78. In this manner, a conductive thin film 411F, which covers  
5 part of the surface of the device electrodes 76A, part of the surface of the device electrodes 76B, and the surface of the exposed support substrate between the device electrodes 76A and the device electrodes 76B, is formed in each of the pixel regions.

Next, electron emission sections 411D are formed on part of the conductive thin film 411F by applying a predetermined, pulsed voltage between the device electrodes  
10 76A and the device electrodes 76B. Here it is preferable to apply a voltage between the device electrodes 76A and the device electrodes 76B under either an organic atmosphere or vacuum condition. This is because it increases the electron emission efficiency from the electron emission sections 411D. The device electrodes 76A, the corresponding device electrodes 76B, and the conductive thin film 411F which is provided with the  
15 electron emission sections 411D, are electron emission elements. Furthermore, each electron emission element corresponds to a pixel region.

The substrate 70A becomes an electron source substrate 70B by the above process as shown in FIG. 17B.

Next, as shown in FIG. 17C, an image display device 70 is obtained by bonding  
20 the electron source substrate 70B and a front substrate 70C by a known method. The front substrate 70C has a glass substrate 82, a plurality of fluorescent sections 84 positioned on the glass substrate 82 in a matrix pattern, and a metal plate 86 covering the plurality of fluorescent sections 84. The metal plate 86 functions as an electrode to accelerate electron beams from the electron emission sections 411D. The electron  
25 source substrate 70B and the front substrate 70C are positioned such that each of the

plurality of electron emission elements faces one of the plurality of fluorescent sections

84. Furthermore, a vacuum condition is maintained between the electron source substrate 70B and the front substrate 70C.

5 In a method of manufacturing such an image display device with electron emission elements, it is also possible to discharge the conductive thin film material 411 satisfactorily by checking the discharge operation of the discharge head 1 in advance prior to the discharge. Thus it is possible to improve the reliability of the image display device obtained.

10 It is possible to manufacture electro-optical devices (devices) such as the above-described liquid crystal device, organic EL device and the like using the droplet discharge apparatus IJ of the present invention. Hereunder is a description of applied examples of electronic equipment incorporating electro-optical devices, which are manufactured by a device manufacturing apparatus IJ having a droplet discharge apparatus.

15 FIG. 18A is a perspective view showing an example of a mobile telephone. In FIG. 18A, numeral 1000 denotes a mobile telephone body, and numeral 1001 denotes a display panel in which the above-described electro-optical device is used. FIG. 18B is a perspective view showing an example of a watch type electronic equipment. In FIG. 18B, numeral 1100 denotes a watch body, and numeral 1101 denotes a display panel  
20 using the above-described electro-optical device. FIG. 18C is a perspective view showing an example of portable type information processing equipment such as a word processor, a personal computer or the like. In FIG. 18C, numeral 1200 denotes the information processing equipment, numeral 1202 an input section such as a keyboard, numeral 1204 an information processing equipment body, and numeral 1206 a display  
25 panel using the above-described electro-optical device. Since the electronic equipment

shown in FIG. 18A to FIG. 18C have electro-optical devices of the above-described embodiment, it is possible to realize electronic equipment having display panels with excellent display quality and bright screens.

In addition to the above examples, other examples are a liquid crystal television,  
5 viewfinder type and monitor direct-view type video tape recorders, a car navigation system, a pager, an electronic notebook, an electronic desk calculator, a word processor, a workstation, a video telephone, a point-of-sale terminal, electronic paper, equipment with a touch panel, and the like. An electro-optical device of the present invention can be used as a display panel of such electronic equipment.

10 While preferred embodiments of the invention have been described and illustrated above, it should be understood that these are exemplary of the invention and are not to be considered as limiting. Additions, omissions, substitutions, and other modifications can be made without departing from the spirit or scope of the present invention. Accordingly, the invention is not to be considered as being limited by the  
15 foregoing description, and is only limited by the scope of the appended claims.